THE INCREDIBLE HUD



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Outline

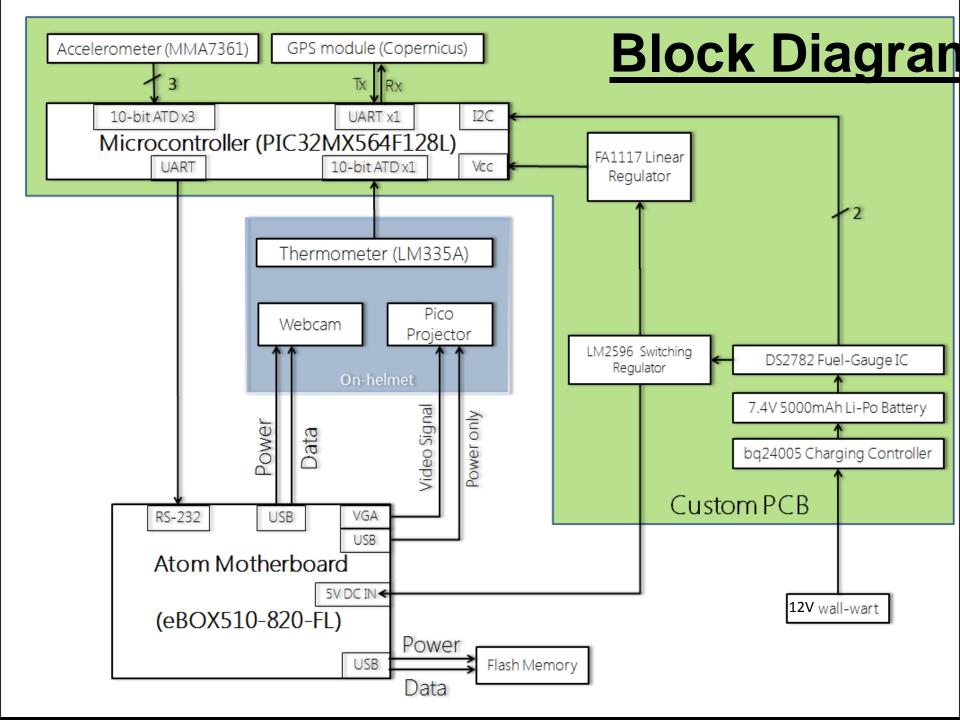
- Project overview
- Project-specific success criteria
- Block diagram
- Component failure calculations
- Failure Groups
- High/Medium-Level Failures
- Software design/development status
- Project completion timeline
- Questions/Discussion

Project Overview

- Helmet-based heads-up display
- Displays telemetry data such as speed, direction, temperature, and G-force
- Displays image from web camera to implement a "rear view mirror"
- The user can select different display modes
- An accelerometer, GPS module, and thermometer will generate telemetry data
- Data will be recorded onto SD card to allow for future review
- The battery pack, motherboard and primary PCB will be located in a secondary backpack enclosure

Project-Specific Success Criteria

- 1. An ability to display critical system information via a heads-up-display (HUD).
- 2. An ability to measure telemetry information (speed, acceleration, temperature, and GPS) and store it to flash memory.
- 3. An ability to maintain portability through the use of a rechargeable battery system.
- 4. An ability to enable/disable important features within the display (full information, minimal, on/off).
- 5. An ability to plot recorded GPS data on a map while overlaying telemetry information on a



Component Failure Times 5V Switching Regulator

Environment factor

Quality factor

Learning factor

Die complexity

Package failure

Quality factor

Learning factor

Failures/10⁶ hours

Mean time to failure

Temperature coeff.

Environment factor

Failures/10⁶ hours

Mean time to failure

.012

3.7

2.0

9.0

10

7.992

0.56

0.19

4.0

10

1.0

3.784

0.56

0.84

4.0

10

1.0

5.104

195,925 hrs

< 0.01

264,271 hrs

< 0.068

125,125 hrs

Assume MOSFET

2-5W Power FET

Junction temperature = 40° C

Junction temperature = 80° C

Ground mobile

 $T = 100^{\circ}C$

Unknown

32-bit

Pins = 128

Unknown

32-bit

Pins = 22

Unknown

Ground mobile

>2 years in production

Ground mobile

>2 years in production

$\lambda_{ m b}$	Type
π_{T}	Temperature coeff.
π_{A}	Application
$\pi_{ m E}$	Environment factor
$\pi_{ m O}$	Quality factor
$\lambda_{ m P}$	Failures/10 ⁶ hours
MTTF	Mean time to failure
Microcontroller	
C_1	Die complexity
π_{T}	Temperature coeff.
C_2	Package failure
1.	

Battery Charging IC

 $\pi_{\rm E}$

 $\pi_{\rm O}$

 $\pi_{
m L}$ $\lambda_{\mathbf{p}}$

 $\pi_{\rm T}$

 $\pi_{\rm E}$

 $\pi_{\rm O}$

 $\pi_{\rm L}$ $\lambda_{\mathbf{P}}$

MTTF

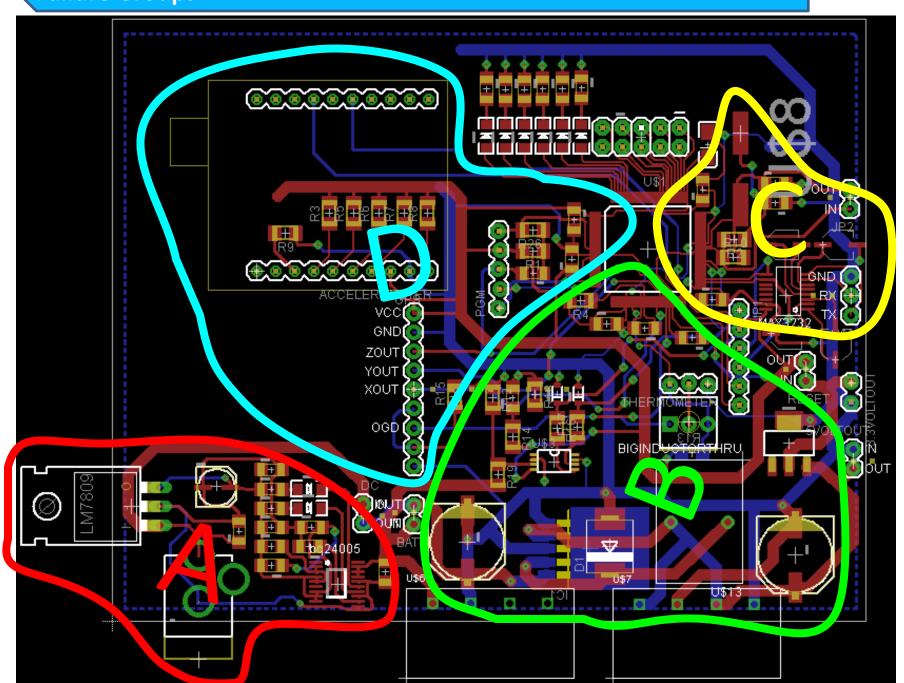
MTTF

Failure Groups

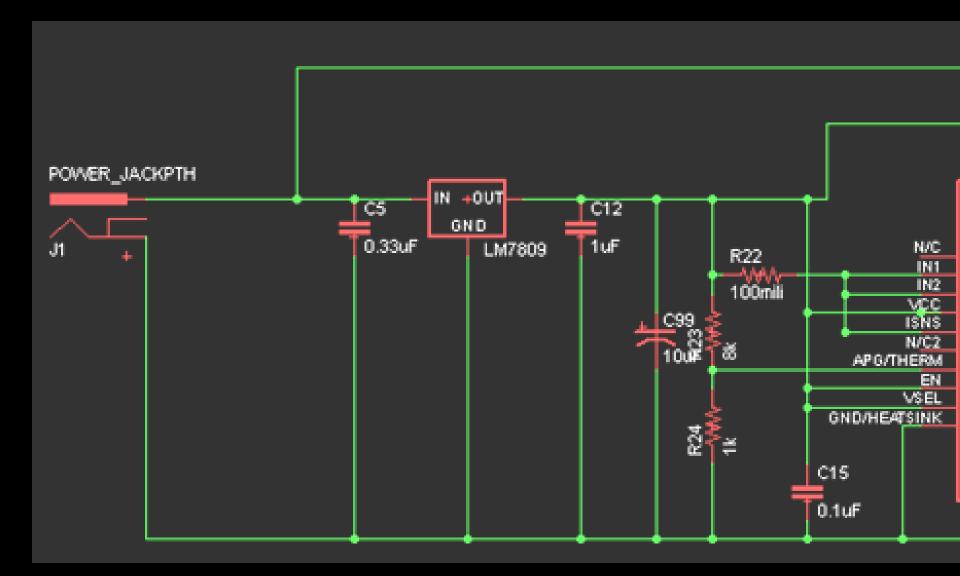
4 Failure Groups:

- A. battery charging circuit
- B. fuel gauge circuit
- C. oscillator and line-level converter
- D. sensors

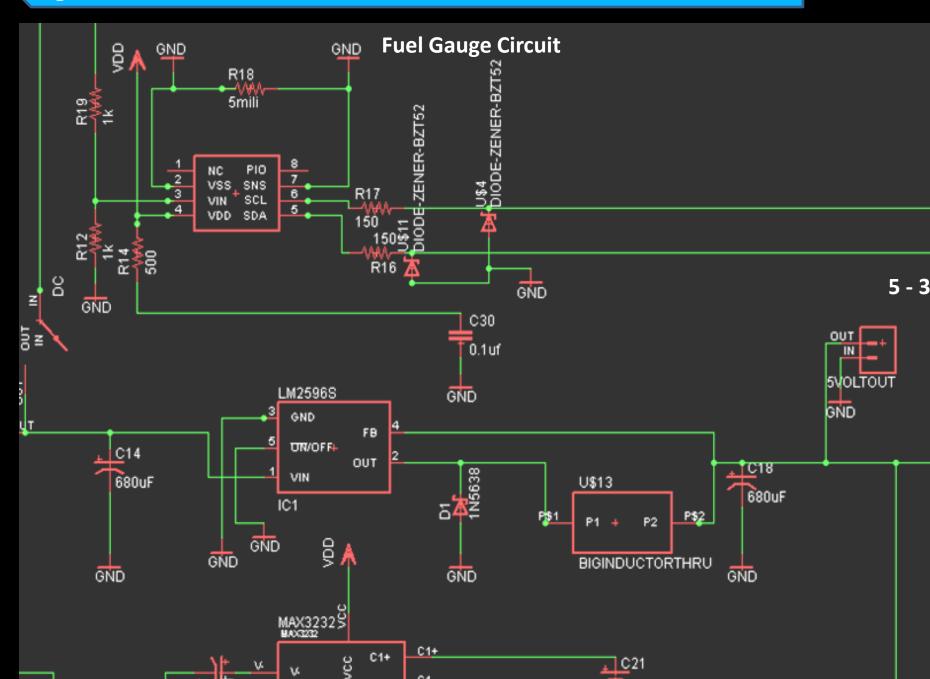
Failure Groups



A-2	Battery overheats and/or catches fire/explodes	Battery fuse shorted and/or internal safety measures to battery fail AND charging IC fails to detect battery charge level (battery and battery charging IC failures)	Battery overheats and potentially catches fire (explodes)	Intense heat followed by potential flaming / exploding battery	High	Absolute worst case scenario for this device
A-3	Battery does not charge to proper level or at all	Battery charging IC failure, LM7809 failure	Battery will not charge or will not charge to full 8.2 volts, possibly no/low voltage on 9v rail	Measure battery voltage, measure 9v output rail, measure voltage across R22	Medium	R22 is a 0.1Ω sense resistor that detects current output to battery.



Battery	Fuel gauge IC	Battery	Measure	Medium	This could
charge level	failure or R18	charge level	R18, R19,		indicate a fuel
reported at	short, R12/R19	reported at	R12 values,		gauge failure that
levels	short/open,	levels	test micro		might result in
inconsistent	microcontroller	inconsistent	I ² C comm.,		attempts to
with actual	I ² C failure	with actual	test replace		overcharge the
levels		levels	fuel gauge		battery.
			IC		
	charge level reported at levels inconsistent with actual	charge level failure or R18 short, R12/R19 levels inconsistent with actual failure or R18 short, R12/R19 short/open, microcontroller I²C failure	charge level failure or R18 charge level reported at levels short/open, inconsistent with actual reported at levels inconsistent with actual reported at levels inconsistent with actual	charge level failure or R18 charge level reported at levels short, R12/R19 reported at levels inconsistent with actual levels levels failure or R18 charge level reported at short, R12/R19 reported at levels levels reported at levels levels reported at levels reported at levels reported at levels levels reported at levels reported at levels reported at levels reported at levels replace fuel gauge	charge level failure or R18 charge level R18, R19, reported at levels short, R12/R19 reported at levels inconsistent with actual levels levels levels reported at levels inconsistent with actual levels levels fuel gauge



Software Design / Development Status

Peripheral Name	Comm. Status	Algorithm	Algorithm Status
PC RS232 Comm.	1xUART Tested OK	Functions to send data packets and receive interrupt	Implemented Tested OK
GPS	1xUART Tested OK	Interpretation of packets received + config if necessary	Unimplemented (medium priority)
Accelerometer	3xADC Tested OK	Conversion of data into g-force measurements	Implemented Tested OK
Thermometer	1xADC Untested	Conversion of data into temperature measurement	Unimplemented (low priority)
Charge Counter	1xl ² C Tested OK	Configuration setup and interpretation of sent packets	Implemented 90% Complete
Buttons	7xGPIO 1 Tested	Sampling of buttons + assignment to actions	1 Implemented Tested OK
GUI elements on Atom	1xRS232 Tested OK	Display GUI, receive/interpret packets from PIC32	In development ~20% Complete

Project Completion Timeline

Week#	Objectives and Milestones
Week 08	Finish PCB adjustments pending Design Review & Course Staff feedback, prototype battery management circuitry, mockup helmet GUI – 100% complete
Weeks 09- 10	Complete PCB Design & send for fabrication, begin intensive motherboard software development, backpack unit specification – 100% complete
Week 11	Receive PCB and begin population, procure backpack unit housing, further develop motherboard software and helmet GUI – 100% complete
Week 12	PCB population should be nearly complete, Debug PCB, begin testing on a system level, begin software testing, begin 'companion application' development (for logged data)
Week 13	Debug software and hardware, continue system level testing, continue companion application development, GPS and thermometer algorithms
Week 14	Debug software and hardware, continue system level testing, continue companion application development
Week 15	Debug software and hardware, continue system level testing, continue companion application development
Week 16	Demonstrate PSSCs and submit final report and poster

Questions?